



CHENMKO ENTERPRISE CO.,LTD

Halogens free devices

SURFACE MOUNT

Dual Digital Silicon Transistor

VOLTAGE 50 Volts CURRENT 100 mAmpere

CHIMD8GP

APPLICATION

- * Switching circuit, Inverter, Interface circuit, Driver circuit.

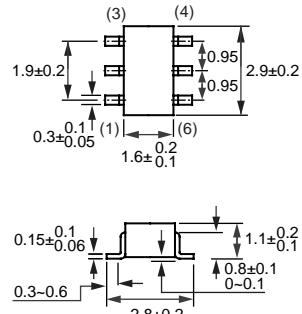
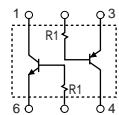
FEATURE

- * Small surface mounting type. (SC-74/SOT-457)
- * High current gain.
- * Suitable for high packing density.
- * Low collector-emitter saturation.
- * High saturation current capability.
- * Both the CHDTA144T & CHDTC144T in one package.
- * Built in bias resistor($R_1=47\text{k}\Omega$, Typ.)



SC-74/SOT-457

CIRCUIT



Dimensions in millimeters

SC-74/SOT-457

CHDTA144T LIMITING VALUES

In accordance with the Absolute Maximum Rating System .

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
V_{CBO}	Collector-Base voltage		-50	V
V_{CEO}	Collector-Emitter voltage		-50	V
V_{EBO}	Emitter-Base voltage		-5	V
I_C	Collector current		-100	mA
P_C	Collector Power dissipation	$T_{amb} \leq 25^\circ\text{C}$, Note 1	300	mW
T_{STG}	Storage temperature		-55 +150	°C
T_J	Junction temperature		-55 +150	°C
$R_{\theta J-S}$	Thermal resistance , Note 1	junction - soldering point	140	°C/W

Note

- Transistor mounted on an FR4 printed-circuit board.

CHDTC144T LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
V _{CBO}	Collector-Base voltage		50	V
V _{C EO}	Collector-Emitter voltage		50	V
V _{EBO}	Emitter-Base voltage		5	V
I _C (Max.)	Collector current		100	mA
P _D	Power dissipation	T _{amb} ≤ 25 °C, Note 1	150	mW
T _{STG}	Storage temperature		-55 +150	°C
T _J	Junction temperature		-55 +150	°C
R _{θJ-S}	Thermal resistance , Note 1	junction - soldering point	140	°C/W

Note

- Transistor mounted on an FR4 printed-circuit board.

CHDTA144T CHARACTERISTICS

T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
BV _{CBO}	Collector-Base breakdown voltage	I _C = -50uA	-50.0	—	—	V
BV _{C EO}	Collector-Emitter breakdown voltage	I _C = -1mA	-50.0	—	—	V
BV _{EBO}	Emitter-Base breakdown voltage	I _E = -50uA	-5.0	—	—	V
V _{C E(sat)}	Collector-Emitter Saturation voltage	I _C = -5mA; I _B = -0.5mA	—	—	-0.3	V
I _{CBO}	Collector-Base current	V _{CB} = -50V	—	—	-0.5	uA
I _{EBO}	Emitter-Base current	V _{EB} = -4V	—	—	-0.5	uA
h _{FE}	DC current gain	I _C = -1mA; V _{C E} = -5.0V	100	250	600	
R ₁	Input resistor		32.9	47	61.1	KΩ
f _T	Transition frequency	I _E =5mA, V _{C E} = -10.0V f=100MHz	—	250	—	MHz

Note

- Pulse test: tp≤300uS; δ≤0.02.

CHDTC144T CHARACTERISTICS

T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
BV _{CBO}	Collector-base breakdown voltage	I _C =50uA	50	—	—	V
BV _{C EO}	Collector-emitter breakdown voltage	I _C =1.0mA	50	—	—	V
BV _{EBO}	Emitter-base breakdown voltage	I _E =50uA	5.0	—	—	V
I _{CBO}	Collector cutoff current	V _{CB} =50V	—	—	0.5	uA
I _{EBO}	Emitter cutoff current	V _{EB} =4V	—	—	0.5	uA
V _{C E(sat)}	Collector-emitter saturation voltage	I _C /I _B =5mA/0.5mA	—	—	0.3	V
h _{FE}	DC current gain	I _C =1mA; V _{C E} =5.0V	100	250	600	
R ₁	Input resistor		32.9	47	61.1	KΩ
f _T	Transition frequency	I _C =5mA, V _{C E} =10.0V f=100MHz	—	250	—	MHz

Note

- Pulse test: tp≤300uS; δ≤0.02.

RATING CHARACTERISTIC CURVES (CHIMD8GP)

CHDTA144T Typical Electrical Characteristics

Fig.1 DC current gain vs. collector current

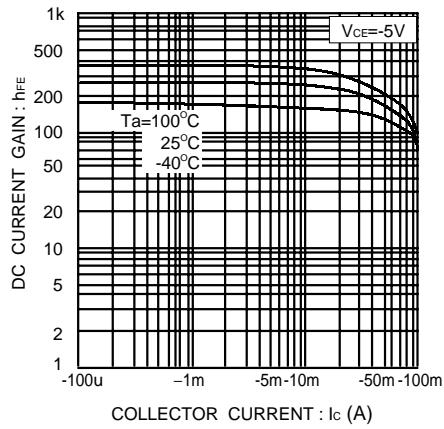
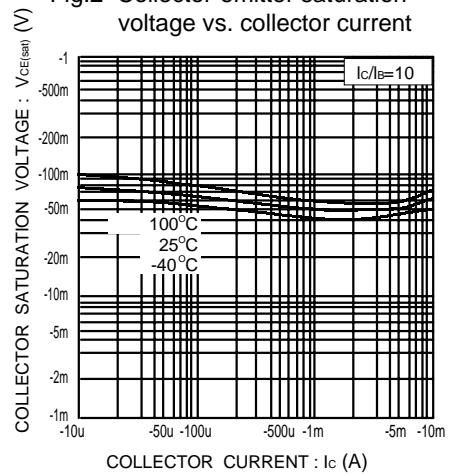


Fig.2 Collector-emitter saturation voltage vs. collector current



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CHDTC144T Typical Electrical Characteristics

Fig.1 DC current gain vs. collector current

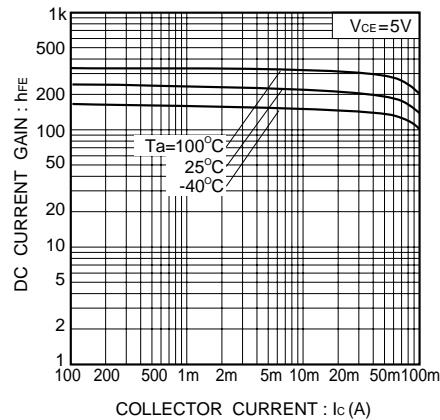


Fig.2 Collector-emitter voltage vs. collector current

